

Amendments to the Specification

Please replace the paragraph beginning on line 5 of page 8 with the following amended paragraph:

But one preferred embodiment interfacial structure is shown in various attributes in Figs. 2-10. The invention also contemplates the interfacial structure for a semiconductor substrate processing chamber and substrate transfer chamber in various subcombinations as literally worded in the accompanying claims and as interpreted in accordance with the doctrine of equivalents. Referring initially to Figs. 2-5, interfacial structure 15 comprises a body 16 sized and shaped to engage with and between a semiconductor substrate processing chamber and a substrate transfer chamber. Body 16 comprises a mass 18 of substantially non-metallic and thermally insulative material. In the context of this document, "substantially non-metallic" defines a material having less than 50% by volume metal therein, with "metal" in such definition referring to that in elemental or alloy form. Also in the context of this document, "substantially metallic" defines a material having at least 50% by volume metal as just defined. Further in the context of this document, "thermally insulative material" defines a substance having a thermal conductivity of less than or equal to

0.02 W/cm-K. The invention was reduced-to-practice in forming mass 18 to comprise Delrin 111P sold by DuPont Engineering Polymers of Newark, Delaware. Such a material is understood to be polymeric. Aspects of the invention also contemplate substantially non-metallic and thermally insulative materials such as gels, ceramics, porous materials (i.e., foams), glass and others, by way of examples only. Of course, such materials might be combined or employ other materials therein, as long as such are substantially non-metallic and thermally insulative as defined herein where such language is specifically literally used in a concluding claim. Further by way of example only, such materials might include combinations of, a) solid and liquid, b) solid and gas, c) liquid and gas, and ~~e) solid, d) solid,~~ liquid and gas. Further by way of ~~example one~~ example only, such material may or may not be homogenous.